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LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT

APPLICANTS: Martin KRUEMPELMANN et al. GROUP ART UNIT: To Be Assigned
 SERIAL NO.: 10/555,956 ATTY. DOCKET NO.: P70882US0
 FILING DATE: November 7, 2005 TODAY'S DATE: May 23, 2006

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE (If Appropriate)
/Y.C./	AA	3,963,902	06/19/76	Dowd			
/Y.C./	AB	4,484,522	11/27/84	Simeth			
/Y.C./	AC	5,551,339	09/03/96	Schädlich et al.			
/Y.C./	AD	5,778,779	07/14/98	Jones et al.			
/Y.C./	AE	6,293,194 B1	09/25/01	Vrotacoe			
/Y.C./	AF	6,314,883 B1	11/13/01	Wech			
/Y.C./	AG	6,634,297 B2	10/21/03	Poetter et al.			

FOREIGN PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	Translation	
							(Yes)	(No)
/Y.C./	AH	DE 31 36 703 C1	11/04/82	DE			Equivalent	
/Y.C./	AI	GB 2 146 291 A	04/17/85	GB				
/Y.C./	AJ	CA 12 23 150	06/23/87	CA			Equivalent	
/Y.C./	AK	CH 667 425 A5	10/14/88	CH			Equivalent	
/Y.C./	AL	DE 42 39 089 A1	11/11/93	DE			Abstract	
/Y.C./	AM	DE 44 01 269 A1	07/20/95	DE			Equivalent	
/Y.C./	AN	EP 0 806 294 B1	11/12/97	EP			Equivalent	
/Y.C./	AO	DE 297 20 928 U1	02/19/98	DE			Specification	
/Y.C./	AP	EP 0 835 753 A1	04/15/98	EP				
/Y.C./	AQ	DE 198 32 892 A1	01/27/00	DE			Abstract	
/Y.C./	AR	DE 198 54 343 A1	05/31/00	DE			Equivalent	
/Y.C./	AS	EP 1 205 300 A1	05/15/02	EP				
/Y.C./	AT	DE 101 45 957 A1	10/17/02	DE			Equivalent	
/Y.C./	AU	WO 2004 048092 A2	06/10/04	WIPO			Abstract	
/Y.C./	AV	DE 102 54 836 A1	06/17/04	DE			Equivalent	

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

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EXAMINER	/Yuan Chen/	DATE CONSIDERED	11/28/2007
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EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).